

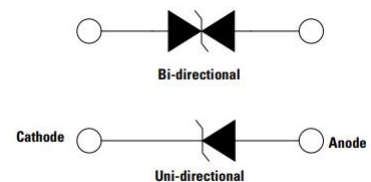
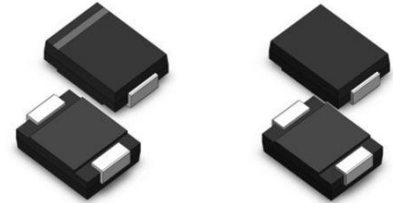


TVS Diodes SMCJ series

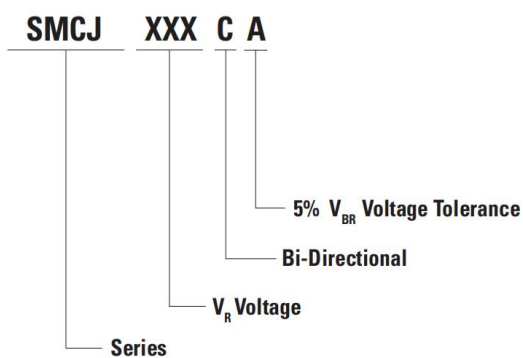
Transient Voltage Suppressors

Features

- ◆ 1500W peak pulse power capability at 10/1000μs Waveform, repetition rate (duty cycle): 0.01%
- ◆ For surface mounted applications to optimize board space
- ◆ Low incremental surge impedance
- ◆ Excellent clamping capability
- ◆ Typical I_R less than 1μA when V_{BR} min>12V
- ◆ High Temperature soldering guaranteed: 260°C/30 Seconds at terminals
- ◆ Plastic package has underwriters laboratory flammability 94V-0
- ◆ Meets MSL level 1, per J-STD-020
- ◆ Meet Halogen free and RoHS compliant



Part Number Coding System



Applications

- ◆ I/O interface
- ◆ AC/DC power supply
- ◆ Low frequency signal transmission line(RS232,RS485,etc.)

Mechanical Data

- ◆ Case: JEDEC DO-214AB
- ◆ Polarity: Color band denotes positive end (cathode) except bi-directional models
- ◆ Weight: About 0.21g

Maximum Rating and Characteristics

Parameters at 25°C ambient temperature unless otherwise Noted.

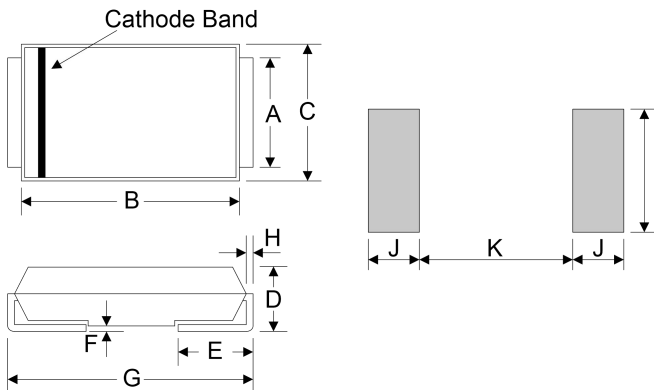
Rating	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10/1000us Test Waveform(Fig.2) (Note 1),(Note 2)-Single Die Parts	P_{PPM}	1500	Watts
Peak Pulse Power Dissipation by 10/1000us Test Waveform(Fig.2) (Note 1), (Note 2)-Stacked Die Parts (Note 5)	P_{PPM}	2000	Watts
Power Dissipation on Infinite Heat Sink at $T_L = 50^\circ\text{C}$	P_D	6.5	Watts
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I_{FSM}	200	Amps
Maximum Instantaneous Forward Voltage at 50A for Unidirectional Only (Note 4)	V_F	3.5/5.0	V
Operating Temperature Range	T_J	-65 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to + 175	$^\circ\text{C}$

Notes:

- 1.Non-repetitive current pulse , per Fig. 2 and derated above T_J (initial) $= 25^\circ\text{C}$ per Fig. 1.
- 2.Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
- 3.Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum.
4. $V_F < 3.5\text{V}$ for single die parts and $V_F < 5.0\text{V}$ for stacked-die parts.

Dimensions (SMC)

Ref.	Millimeters		Inches	
	Min	Max	Min.	Max.
A	2.900	3.200	0.114	0.126
B	6.600	7.110	0.260	0.280
C	5.590	6.220	0.220	0.245
D	2.060	2.620	0.079	0.103
E	0.760	1.520	0.030	0.060
F	-	0.203	-	0.008
G	7.750	8.130	0.305	0.320
H	0.152	0.305	0.006	0.012
I	3.300	-	0.129	-
J	2.400	-	0.094	-
K	-	4.200	-	0.165



Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Part Number		Device Marking Code		Reverse Stand-Off Voltage	Breakdown Voltage @ I_T	Test Current	Maximum Clamping Voltage @ I_{PP}	Peak Pulse Current	Reverse Leakage @ V_{RWM}
Unidirectional	Bidirectional	UNI	BI	$V_{RWM}(V)$	$V_{BR}(V)$	$I_T(mA)$	$V_C(V)$	$I_{PP}(A)$	$I_R(\mu A)$
SMCJ5.0A	SMCJ5.0CA	GDE	BDE	5.0	6.40~7.00	10	9.2	163.0	800
SMCJ6.0A	SMCJ6.0CA	GDG	BDG	6.0	6.67~7.37	10	10.3	145.7	800
SMCJ6.5A	SMCJ6.5CA	GDK	BDK	6.5	7.22~7.98	10	11.2	134.0	500
SMCJ7.0A	SMCJ7.0CA	GDM	BDM	7.0	7.78~8.60	10	12.0	125.0	200
SMCJ7.5A	SMCJ7.5CA	GDP	BDP	7.5	8.33~9.21	1	12.9	116.3	100
SMCJ8.0A	SMCJ8.0CA	GDR	BDR	8.0	8.89~9.83	1	13.6	110.3	50
SMCJ8.5A	SMCJ8.5CA	GDT	BDT	8.5	9.44~10.40	1	14.4	104.2	20
SMCJ9.0A	SMCJ9.0CA	GDV	BDV	9.0	10.00~11.10	1	15.4	97.4	10
SMCJ10A	SMCJ10CA	GDX	BDX	10.0	11.10~12.30	1	17.0	88.3	5
SMCJ11A	SMCJ11CA	GDZ	BDZ	11.0	12.20~13.50	1	18.2	82.5	1
SMCJ12A	SMCJ12CA	GEE	BEE	12.0	13.30~14.70	1	19.9	75.4	1
SMCJ13A	SMCJ13CA	GEG	BEG	13.0	14.40~15.90	1	21.5	69.8	1
SMCJ14A	SMCJ14CA	GEK	BEK	14.0	15.60~17.20	1	23.2	64.7	1
SMCJ15A	SMCJ15CA	GEM	BEM	15.0	16.70~18.50	1	24.4	61.5	1
SMCJ16A	SMCJ16CA	GEP	BEP	16.0	17.80~19.70	1	26.0	57.7	1
SMCJ17A	SMCJ17CA	GER	BER	17.0	18.90~20.90	1	27.6	54.4	1
SMCJ18A	SMCJ18CA	GET	BET	18.0	20.00~22.10	1	29.2	51.4	1
SMCJ20A	SMCJ20CA	GEV	BEV	20.0	22.20~24.50	1	32.4	46.3	1
SMCJ22A	SMCJ22CA	GEX	BEX	22.0	24.40~26.90	1	35.5	42.3	1
SMCJ24A	SMCJ24CA	GEZ	BEZ	24.0	26.70~29.50	1	38.9	38.6	1
SMCJ26A	SMCJ26CA	GFE	BFE	26.0	28.90~31.90	1	42.1	35.7	1
SMCJ28A	SMCJ28CA	GFG	BFG	28.0	31.10~34.40	1	45.4	33.1	1
SMCJ30A	SMCJ30CA	GFK	BFK	30.0	33.30~36.80	1	48.4	31.0	1
SMCJ33A	SMCJ33CA	GFM	BFM	33.0	36.70~40.60	1	53.3	28.2	1
SMCJ36A	SMCJ36CA	GFP	BFP	36.0	40.00~44.20	1	58.1	25.9	1
SMCJ40A	SMCJ40CA	GFR	BFR	40.0	44.40~49.10	1	64.5	23.3	1
SMCJ43A	SMCJ43CA	GFT	BFT	43.0	47.80~52.80	1	69.4	21.7	1
SMCJ45A	SMCJ45CA	GFV	BFV	45.0	50.00~55.30	1	72.7	20.6	1
SMCJ48A	SMCJ48CA	GFX	BFX	48.0	53.30~58.90	1	77.4	19.4	1
SMCJ51A	SMCJ51CA	GFZ	BFZ	51.0	56.70~62.70	1	82.4	18.2	1
SMCJ54A	SMCJ54CA	GGE	BGE	54.0	60.00~66.30	1	87.1	17.3	1
SMCJ58A	SMCJ58CA	GGG	BGG	58.0	64.40~71.20	1	93.6	16.1	1
SMCJ60A	SMCJ60CA	GGK	BGK	60.0	66.70~73.70	1	96.8	15.5	1
SMCJ64A	SMCJ64CA	GGM	BGM	64.0	71.10~78.60	1	103.0	14.6	1
SMCJ70A	SMCJ70CA	GGP	BGP	70.0	77.80~86.00	1	113.0	13.3	1
SMCJ75A	SMCJ75CA	GGR	BGR	75.0	83.30~92.10	1	121.0	12.4	1
SMCJ78A	SMCJ78CA	GGT	BGT	78.0	86.70~95.80	1	126.0	11.9	1

Part Number		Device Marking Code		Reverse Stand-Off Voltage	Breakdown Voltage @ I_T	Test Current	Maximum Clamping Voltage @ I_{PP}	Peak Pulse Current	Reverse Leakage @ V_{RWM}
Unidirectional	Bidirectional	UNI	BI	$V_{RWM}(V)$	$V_{BR}(V)$	$I_T(mA)$	$V_C(V)$	$I_{PP}(A)$	$I_R(\mu A)$
SMCJ85A	SMCJ85CA	GGV	BGV	85.0	94.40~104.00	1	137.0	11.0	1
SMCJ90A	SMCJ90CA	GGX	BGX	90.0	100.00~111.00	1	146.0	10.3	1
SMCJ100A	SMCJ100CA	GGZ	BGZ	100.0	111.00~123.00	1	162.0	9.3	1
SMCJ110A	SMCJ110CA	GHE	BHE	110.0	122.00~135.00	1	177.0	8.5	1
SMCJ120A	SMCJ120CA	GHG	BHG	120.0	133.00~147.00	1	193.0	7.8	1
SMCJ130A	SMCJ130CA	GHK	BHK	130.0	144.00~159.00	1	209.0	7.2	1
SMCJ150A	SMCJ150CA	GHM	BHM	150.0	167.00~185.00	1	243.0	6.2	1
SMCJ160A	SMCJ160CA	GHP	BHP	160.0	178.00~197.00	1	259.0	5.8	1
SMCJ170A	SMCJ170CA	GHR	BHR	170.0	189.00~209.00	1	275.0	5.5	1
SMCJ180A	SMCJ180CA	GHT	BHT	180.0	201.00~222.00	1	292.0	5.1	1
SMCJ190A	SMCJ190CA	GHU	BHU	190.0	211.00~233.00	1	308.0	4.8	1
SMCJ200A	SMCJ200CA	GHV	BHV	200.0	224.00~247.00	1	324.0	4.6	1
SMCJ210A	SMCJ210CA	GHW	BHW	210.0	237.00~263.00	1	340.0	4.4	1
SMCJ220A	SMCJ220CA	GHX	BHX	220.0	246.00~272.00	1	356.0	4.2	1
SMCJ250A	SMCJ250CA	GHZ	BHZ	250.0	279.00~309.00	1	405.0	3.7	1
SMCJ300A*	SMCJ300CA*	GJE	BJE	300.0	335.00~371.00	1	486.0	4.1	1
SMCJ350A*	SMCJ350CA*	GJG	BJG	350.0	391.00~432.00	1	567.0	3.5	1
SMCJ400A*	SMCJ400CA*	GJK	BJK	400.0	447.00~494.00	1	648.0	3.0	1
SMCJ440A*	SMCJ440CA*	GJM	BJM	440.0	492.00~543.00	1	713.0	2.8	1

- Notes:**
- 1.For bidirectional type having V_{RWM} of 10V and less, the I_R limit is double.
 - 2.For parts without A , the V_{BR} is $\pm 10\%$ and V_C is 5% higher than with A parts, the parts without A are currently available, but not recommended for new designs. The parts with A are preferred.
 - 3.For stack-die parts, use * to label the part number.

Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1. Peak Pulse Power Derating Curve

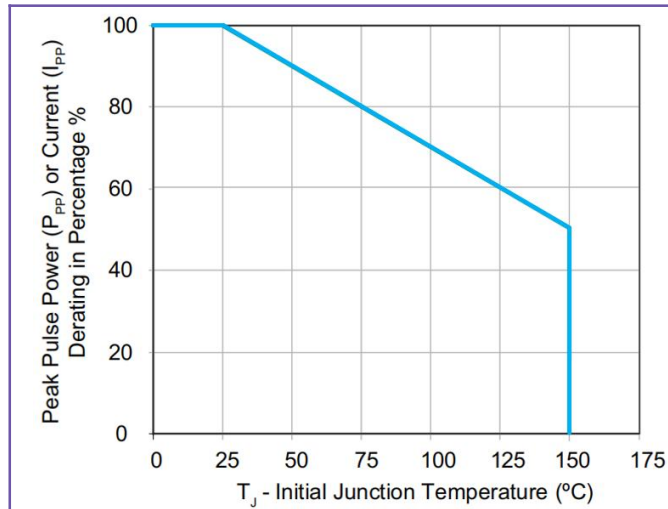


Figure 2. Pulse Waveform

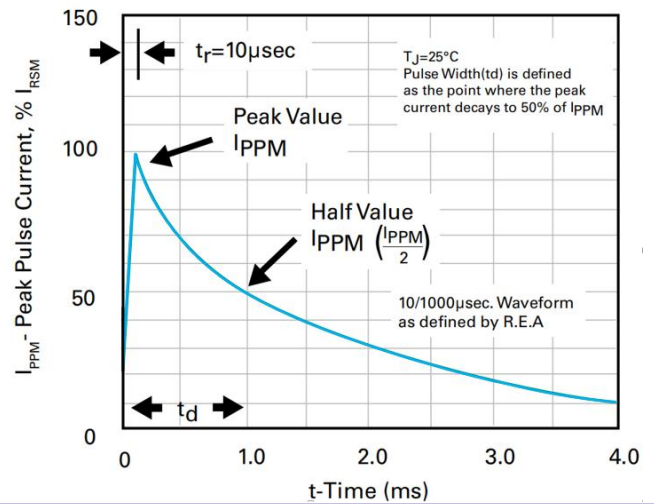


Figure 3. Typical Junction Capacitance

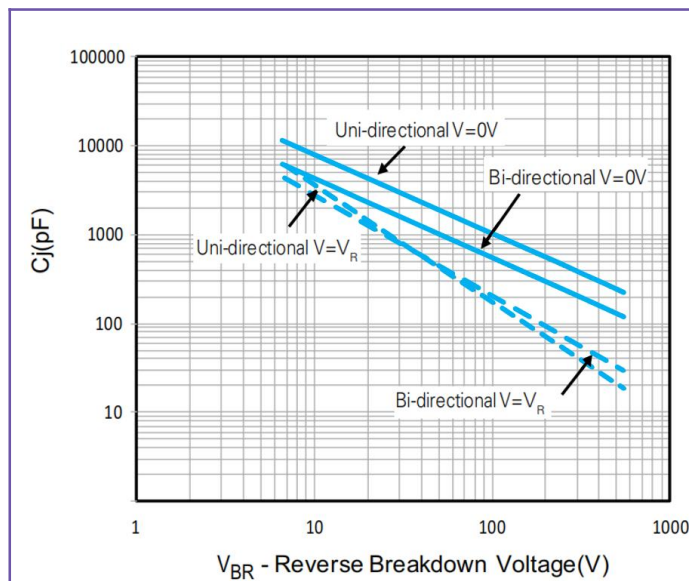


Figure 4. Typical Transient Thermal Impedance

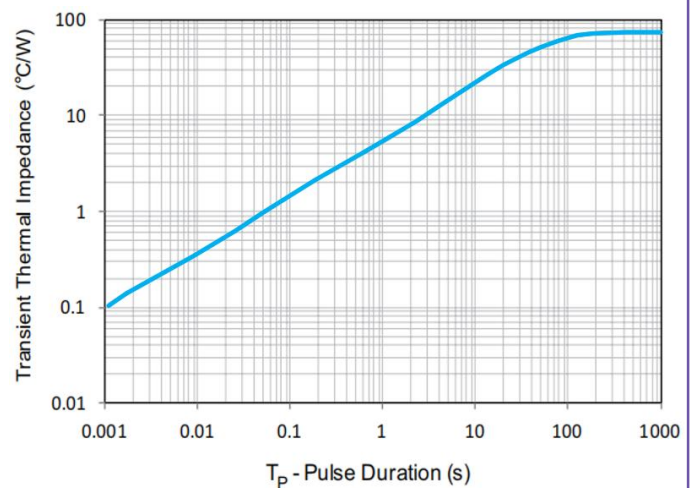


Figure 5. Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

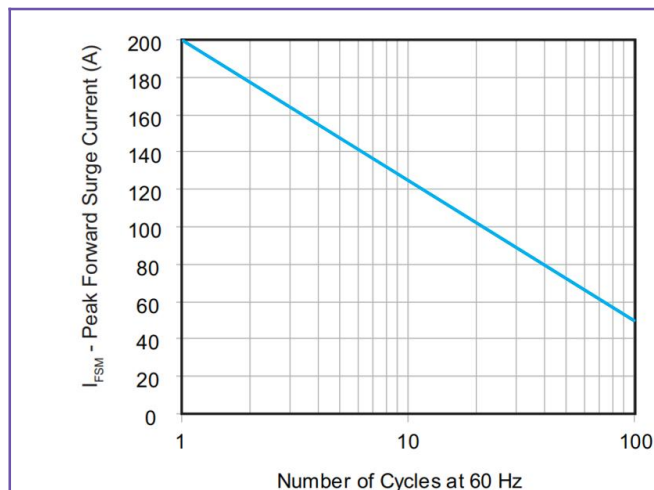
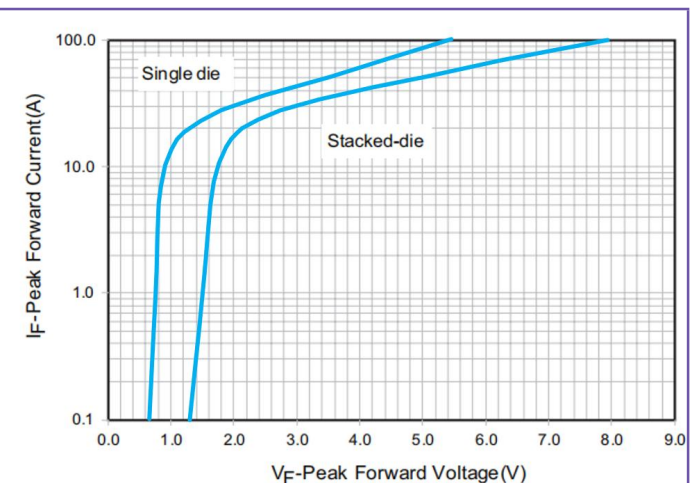
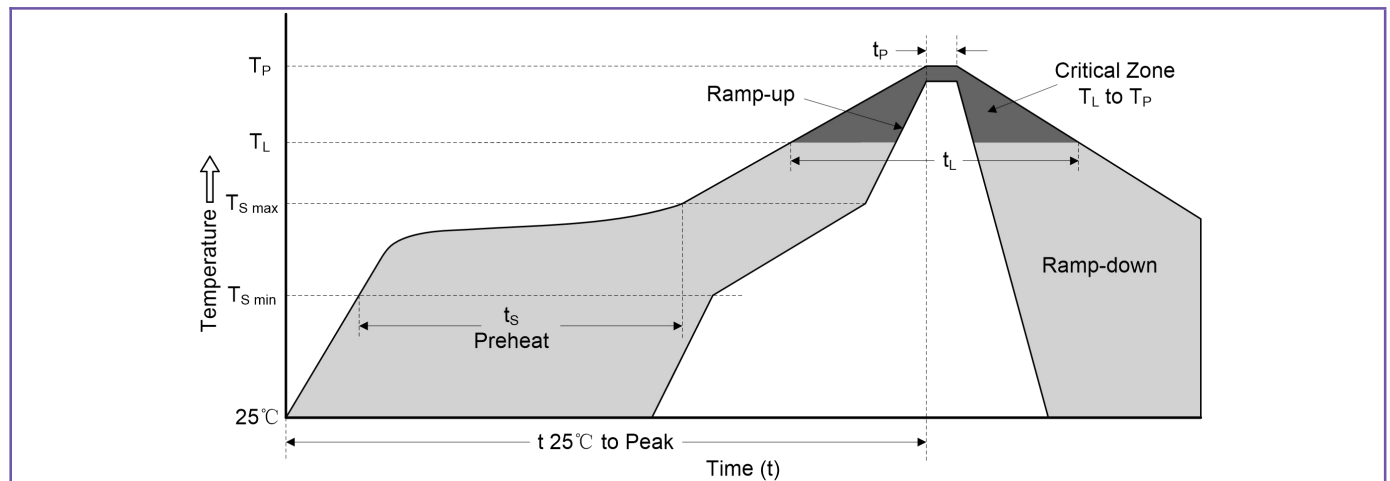


Figure 6. Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)



Reflow Soldering Parameters



Reflow Condition		Lead-free Assembly
Pre heat	-Temperature Min ($T_{S\ min}$)	150°C
	-Temperature Max ($T_{S\ max}$)	200°C
	-Time (min to max) (t_s)	60-120 seconds
Average ramp-up rate (T_L to T_P)		3°C/second max.
$T_{S\ max}$ to T_L -Ramp-up Rate		3°C/second max.
Reflow	-Temperature (T_L) (Liquidus)	217°C
	-Time (min to max) (t_s)	60-150 seconds
Peak Temperature (T_P)		260(+0/-5)°C
Time within 5°C of actual Peak Temperature (t_p)		30 seconds
Ramp-down Rate		6°C/second max.
Time 25°C to Peak Temperature(T_P)		8 minutes max.
Do not exceed		260°C

Reliability

Items	Standards
Terminal strength	MIL-STD-750 Method 2036
Mechanical shock	JESD22-B104
Vibration	JESD22-B103
High Temp. Storage	JESD22-A103
High Temp Reverse Bias	JESD22-A108
Temperature Cycling	JESD22-A104
High Temp High Humidity Reverse Bias	JESD22-A101
Resistance to solder heat	JESD22-A111(SMD)